

RECOMMENDED PCB LAYOUT

TOLERANCE IS ± 0.05

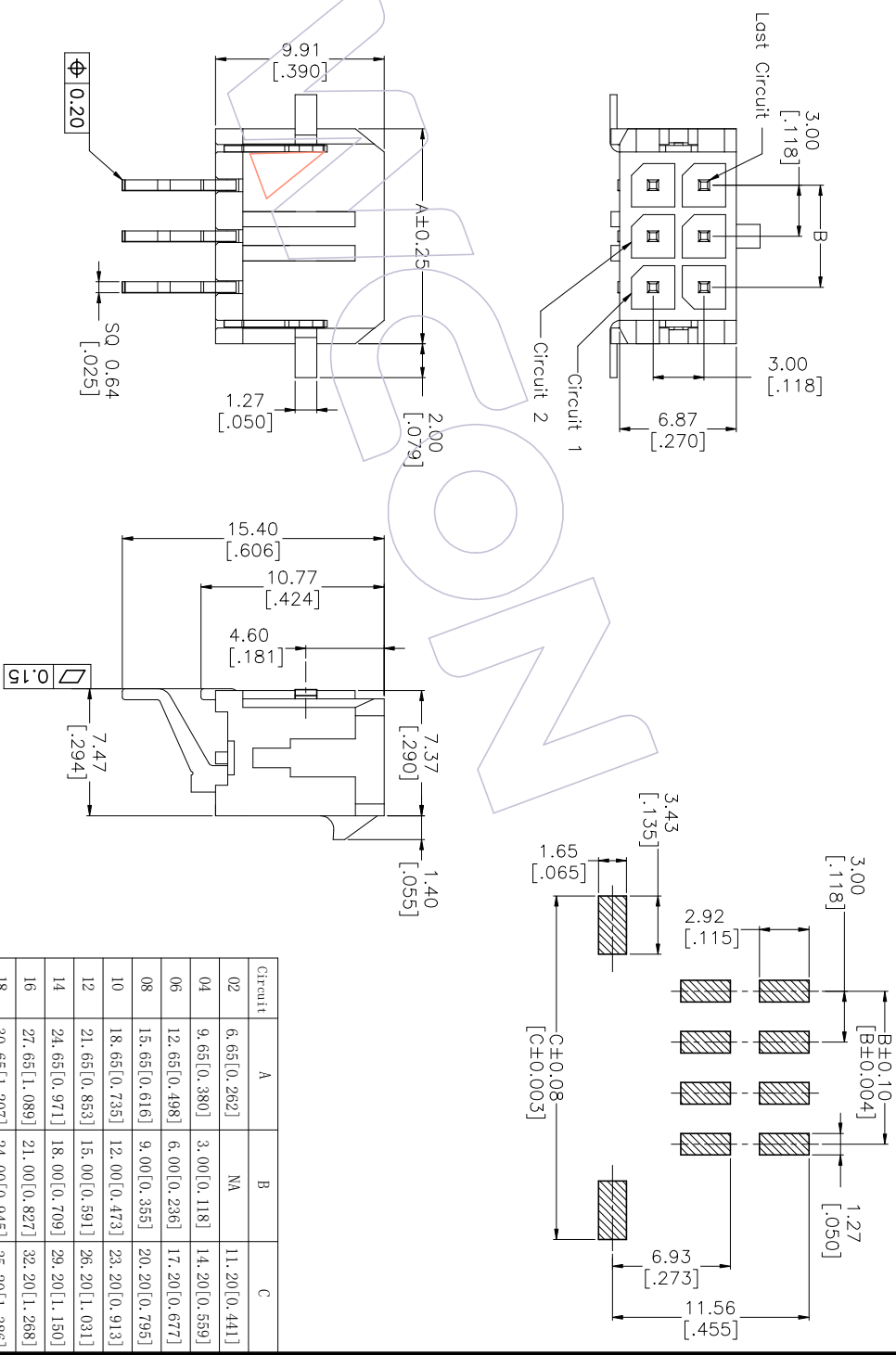
NOTES:

Current Rating:5.0A AMP
Contact Resistance:10milliohm Max
Withstand Voltage:1000V AC/Minute
Insulation Resistance:1000Megohm Min
Operation Temperature:−40℃ to +105℃
Housing Material: LCP+30%GF(UL94V-0)
Contact Material: Copper alloy
Contact plating: Au / Sn over Ni Plating

Ordering Information

WF3001-2 WZ XX B X 3

Terminal shape:	NO. of Pins Per	Packing:
W.Z. Wafer 90°SMT	Row:01~12Pin	A=Tray R=Tape&Reel



Circuit	A	B	C
02	6.65 [0.262]	NA	11.20 [0.441]
04	9.65 [0.380]	3.00 [0.118]	14.20 [0.559]
06	12.65 [0.498]	6.00 [0.236]	17.20 [0.677]
08	15.65 [0.616]	9.00 [0.355]	20.20 [0.795]
10	18.65 [0.735]	12.00 [0.473]	23.20 [0.913]
12	21.65 [0.853]	15.00 [0.591]	26.20 [1.031]
14	24.65 [0.971]	18.00 [0.709]	29.20 [1.150]
16	27.65 [1.089]	21.00 [0.827]	32.20 [1.268]
18	30.65 [1.207]	24.00 [0.945]	35.20 [1.386]
20	33.65 [1.325]	27.00 [1.063]	38.20 [1.504]
22	36.65 [1.443]	30.00 [1.181]	41.20 [1.622]
24	39.65 [1.561]	33.00 [1.299]	44.20 [1.740]

[illegible]